

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2857959

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KAI YUN YOW	09/18/2013
POH LENG EU	09/18/2013
MENG KONG LYE	09/18/2013
YOU GE	09/18/2013
PENGLIN MEI	09/18/2013
RECEIVING PARTY DATA	
Name:	Freescle Semiconductor, Inc.
Street Address:	6501 William Cannon Drive West
Internal Address:	Law Department
City:	Austin
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14277801
CORRESPONDENCE DATA	
Fax Number:	(512)895-6630
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Correspondent Name:	DEE MATOCHA
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Address Line 4:	AUSTIN, TEXAS 78735
ATTORNEY DOCKET NUMBER:	MT12271AK
NAME OF SUBMITTER:	CASSIE YE
SIGNATURE:	/Cassie Ye/
DATE SIGNED:	05/15/2014
Total Attachments: 6	

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ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **KAI YUN YOW, POH LENG EU AND MENG KONG LYE, ALL OF MALAYSIA AND YOU GE AND PENGLIN MEI, BOTH OF THE P.R. CHINA**, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto **FREESCALE SEMICONDUCTOR, INC.**, a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **SEMICONDUCTOR PACKAGE WITH STRESS RELIEF AND HEAT SPREADER** (Docket No. **MT12271AK**), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto **FREESCALE SEMICONDUCTOR, INC.**, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize **FREESCALE SEMICONDUCTOR, INC.** to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to **FREESCALE SEMICONDUCTOR, INC.**, for the sole use and benefit of **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to **FREESCALE SEMICONDUCTOR, INC.**


We agree that, when requested, we will, without charge to **FREESCALE SEMICONDUCTOR, INC.**, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for

MT12271AK
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the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

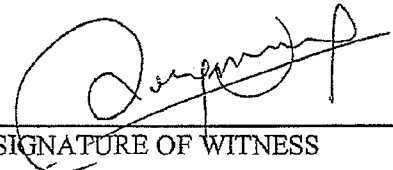
We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.



KAI YUN YOW

DATE: 18/SEPT/2013

First Witness



SIGNATURE OF WITNESS

DATE: 18 Sep 2013
(Month-Day-Year)

LEE YIT MENG

PRINTED NAME OF WITNESS

B57 DANAU IDAMAN CONDOMINIUM, JALAN 2/109F, 58100, KUALA LUMPUR

PRINTED ADDRESS OF WITNESS

Second Witness



SIGNATURE OF WITNESS

DATE: 18-Sep-2013
(Month-Day-Year)

CHAN WEI KEE

PRINTED NAME OF WITNESS

T2-L5-D, BOULEVARD SUBANG, JALAN SS12/1, WANGSA Baiduri, 47500
SUBANG JAYA. SELANGOR

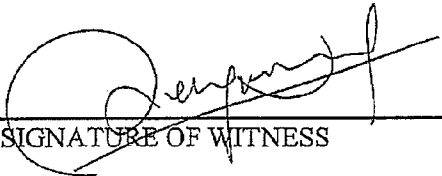
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POH LENG EU

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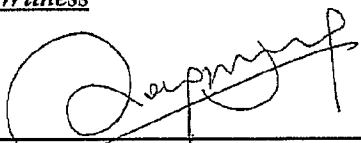
T2-L5-D, BOULEVARD SUBANG, JALAN SS12/1, WANGSA Baiduri, 47500
SUBANG JAYA, SELANGOR

PRINTED ADDRESS OF WITNESS


MENG KONG LYE

DATE: 18/SEPT/2013

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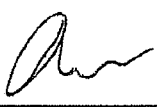

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SUBANG JAYA, SELANGOR
PRINTED ADDRESS OF WITNESS

You Ge
YOU GE

DATE 18 Sep - 2013

First Witness

MARIANO L CHING JR
SIGNATURE OF WITNESS

DATE 18-SEP-2013
(Month-Day-Year)

MARIANO L CHING JR
PRINTED NAME OF WITNESS

NO 15 XINGHUA ROAD, TIANJIN, CHINA
300385
PRINTED ADDRESS OF WITNESS

Second Witness

M. J. Song
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DATE 18 - Sep - 2013
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NO 15 XINGHUA ROAD, TIANJIN, CHINA
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PENG LIN MEI

DATE: 18 - Sep - 2013

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MARIANO L CHING JR
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